SPEC. No. ED-04P008 ISSUE February 26, 2004

SHARP

OPTO-ELECTRONIC DEVICES DIVISION ELECTRONIC COMPONENTS GROUP SHARP CORPORATION

SPECIFICATION

<u> </u>			
DÉVICE SPECII	TCATION FOR		
	PHOTOTRIAC COUPLE	R .	
MODEL No.	5052		
	S2S3		
	(Business dealing name: \$2	S3AD0F)	
Specified for			
		-	
•			
Enclosed please find copies After confirmation of the co with approving signature on	of the Specifications which consist ntents, please be sure to send back each.	ts of 11 pages including cover. 1 copies of the Specifications	
CUSTOMER'S APPROVA	L	PRESENTED	
DATE	···	DATE Mysl, 2000	
ву		BY W. Imenaleu	
		H. Imanaka, Department General Manager of Engineering Dept.,II Opto-Electronic Devices Div. ELECOM Group SHARP CORPORATION	

Product name: PHOTOTRIAC COUPLER

Model No.: S2S3

(Business dealing name: S2S3AD0F)

1.	These specification sheets include materials protected under copyright of Sharp Corporation ("Sharp")
	Please do not reproduce or cause anyone to reproduce them without Sharp's consent.

2. When using this product, please observe the absolute maximum ratings and the instructions for use outlined in these specification sheets, as well as the precautions mentioned below. Sharp assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets, and the precautions mentioned below.

(Precautions)

(1) This product is designed for use in the following application areas;

·OA equipment · Audio visual equipment · Home appliances

· Telecommunication equipment (Terminal) · Measuring equipment

· Tooling machines · Computers

If the use of the product in the above application areas is for equipment listed in paragraphs (2) or (3), please be sure to observe the precautions given in those respective paragraphs.

(2) Appropriate measures, such as fail-safe design and redundant design considering the safety design of the overall system and equipment, should be taken to ensure reliability and safety when this product is used for equipment which demands high reliability and safety in function and precision, such as;

· Transportation control and safety equipment (aircraft, train, automobile etc.)

· Traffic signals · Gas leakage sensor breakers · Rescue and security equipment

· Other safety equipment etc.

(3) Please do not use this product for equipment which require extremely high reliability and safety in function and precision, such as;

• Space equipment • Telecommunication equipment (for trunk lines)

· Nuclear power control equipment · Medical equipment etc.

- (4) Please contact and consult with a Sharp sales representative if there are any questions regarding interpretation of the above three paragraphs.
- 3. Please contact and consult with a Sharp sales representative for any questions about this product.

1. Application

This specification applies to the outline and characteristics of phototriac coupler Model No. S2S3 (Apply line voltage 200V AC).

2. Outline

Refer to the attached sheet, page 4.

3. Ratings and characteristics

Refer to the attached sheet, page 5, 6.

4. Reliability

Refer to the attached sheet, page 7.

5. Outgoing inspection

Refer to the attached sheet, page 8.

- 6. Supplement
 - 6.2 Package specification

Refer to the attached sheet, page 9,10.

- 6.3 Isolation voltage shall be measured in the following method.
 - (1) Short between pins 1 to 2 on the primary side and between pins 3 to 4 on the secondary side.
 - (2) The dielectric withstand tester with zero-cross circuit shall be used.
 - (3) The wave form of applied voltage shall be a sine wave.

(It is recommended that the isolation voltage be measured in insulation oil.)

6.4 This Model is approved by UL, CSA.

Approved Model No.: S2S3

UL file No.: E64380

CSA file No.: CA95323

CSA approved mark "

(I)

" shall be indicated on minimum unit package.

6.5 This product is not designed against irradiation.

This product is assembled with electrical input and output.

This product incorporates non-coherent light emitting diode.

6.6 ODS materials

This product shall not contain the following materials.

Also, the following materials shall not be used in the production process for this product.

Materials for ODS : CFC_S, Halon, Carbon tetrachloride, 1.1.1-Trichloroethane (Methyl chloroform)

6.7 Brominated flame retardants

Specific brominated flame retardants such as the PBBOs and PBBs are not used in this device at all.

7. Notes

7:1 Before the circuit design

- (1) The LED used in the Phototriac coupler generally decreases the light emission power by operation. In case of long operation time, please decide I_F value as 2 times or more of the Maximum value of the Minimum triggering current at circuit design with considering the decreases of the light emission power of the LED. (50%/5years)
- (2) Input current (I_F) at off state shall be set 0.1mA or less.
- (3) In case that pulse drive is carried out, it shall be recommended to use that the pulse width of input signal is 1ms or more.

7.2 Usage

For triggering medium and high power triac. (This model shall be used in the ON state condition of triggering power triac.)

7.3 For cleaning

- (1) Solvent cleaning: Solvent temperature 45°C or less, Immersion for 3 min or less
- (2) Ultrasonic cleaning: The effect to device by ultrasonic cleaning differs

 by cleaning bath size, ultrasonic power

 output, cleaning time, PCB size or device mounting condition etc.

 Please test it in actual using condition

 and confirm that doesn't occur any defect before starting the ultrasonic cleaning.
- (3) Applicable solvent: Ethyl alcohol, Methyl alcohol, Isopropyl alcohol

When the other solvent is used, there are cases that the packaging resin is eroded.

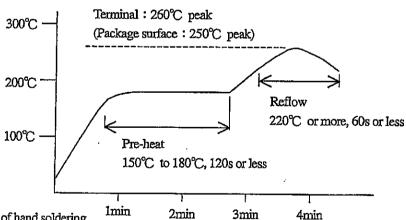
Please use the other solvent after thorough confirmation is performed in actual using condition.

- 7.4 Precautions for Soldering Phototriac couplers
- (1) In the case of flow soldering (Whole dipping is possible.)

 It is recommended that flow solder be at 260°C or less and within 10 seconds (Pre-heating: 100 to 150°C, 30 to 80 seconds).

 (2 times or less)
- (2) If solder reflow:

It is recommended to be done at the temperature and the time within the temperature profile as shown in the figure below. (2 times or less)



(3) In the case of hand soldering

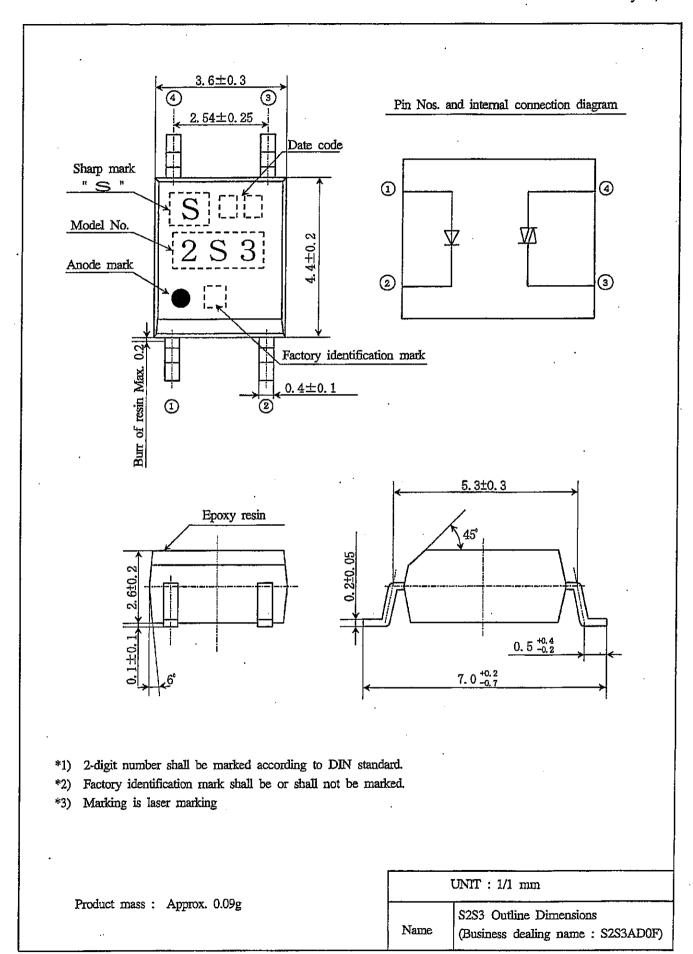
What is done on the following condition is recommended. (2 times or less)

Soldering iron temperature: 400°C or less

Time: 3s or less

(4) Other precautions

Since, influence to the device is different according to reflow equipment and its condition, please use the device after confirming no damage in the actual using condition.



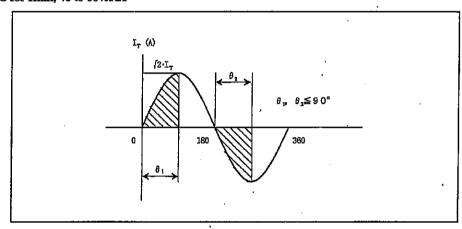
3.1 Absolute maximum ratings

Т	=25	9
14	- /]	٠.

	Parameter	Symbol	Rating	Unit	
T	Forward current	I _F	50	mA	
Input	Reverse voltage	V _R	6 ·	V	
	RMS on-state current *1	I _T (rms)	0.05	A	
Output	Peak one cycle surge current	Isurge	0.6	A	
	Repetitive peak off-state voltage	V _{DRM}	600	V	
	Isolation voltage *2	Viso(rms)	3.75	kV	
	Operating temperature	Topr	-30 to +100	°C	
·	Storage temperature	Tstg	-40 to +125	ဗ	
Soldering temperature		Tsol	260 (For 10s)	°C	

^{*1} The definition for conductive angle of on-state current shall be in accordance with the below drawings. For the derating curve, see Fig.1, 2.

*2 AC for 1min, 40 to 60%RH



3.2 Electrical characteristics

Ta=25°C

	Symbol	MIN.	TYP.	MAX.	Unit	Conditions	
Tonist	Forward voltage	V _F	-	1.2	1.4	V	I _F =20mA
Input	Reverse current	I_R	-	-	10	μА	V _R =3V
	Repetitive peak off-state current	I_{DRM}	-	-	1	μΑ	V _D =V _{DRM}
O	On-state voltage	V _T	-		2.5	V	I ₁ =0.05A
Output	Holding current	I_{H}	0.1	_	3.5	mA	V _D =6V
	Critical rate of rise of off-state voltage	dv/dt	100	1000	-	V/μs	$V_D=1/\sqrt{2} \cdot V_{DRM}$
	Minimum trigger current	$I_{F\Gamma}$	-	#	10	mA	$V_D=6V$ $R_L=100 \Omega$
Transfer characteristics	Isolation resistance	R _{iso}	5×10 ¹⁰	10 ¹¹	<u>.</u>	Ω	DC500V 40 to 60%RH
	Turn on time	t _{ON}	-	-	100	μs	V_D =6V, R_L =100 Ω , I_F =20mA

Fig.1 Forward current vs. ambient temperature

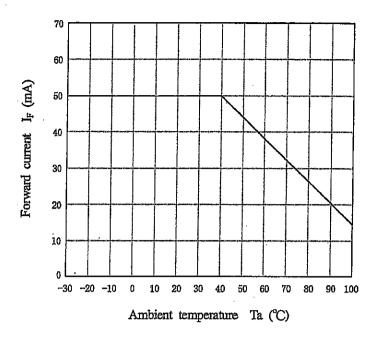
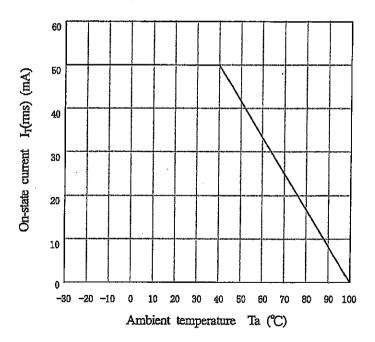


Fig.2 On-state current vs. ambient temperature



4. Reliability

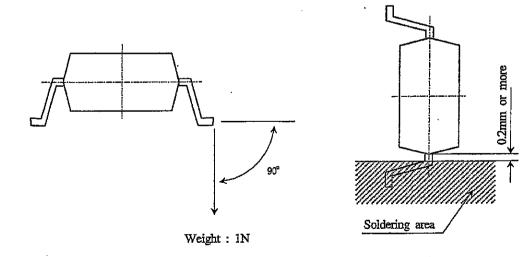
The reliability of products shall satisfy items listed below.

Confidence level: 90%

LTPD: 10 or 20

Test Items	Test Conditions *1	Failure Judgement	Samples (n)	
2.050 Albirin	255 5511445115	Criteria	Defective(C)	
Solderability *2	245±3℃, 5s	-	n=11, C=0	
Soldering heat *3	(Flow soldering) 260°C, 10s		n=11, C=0	
	(Soldering by hand) 400°C, 3 s	_		
Terminal strength	Weight: 1.0N		n=11, C=0	
(Bending) *4	1 time/each terminal	$V_F>U\times 1.2$		
Mechanical shock	15km/s ² , 0.5ms		n=11, C=0	
, and the property of the party	3 times/±X, ±Y, ±Z direction	$V_T>U\times 1.2$		
Variable frequency	100 to 2000 to 100Hz/4min	1 >11>12		
vibration	200m/s ² 4 times/ X, Y, Z direction	$I_{FT}>U\times1.3$	n=11, C=0	
	4 times/ A, 1, 2 timection	I _R >U×2.0		
	1 cycle -40°C to +125°C			
Temperature cycling	(30min) (30min) 20 cycles test Without Load	$I_{DRM}>U\times2.0$	n=22,C=0	
	20 Cycles lest Williout Load	U: Upper specification limit		
High temp, and high	+60°C, 90%RH, 500h	O : Opper specification mini-	n=22,C=0	
humidity storage		L: Lower specification limit		
High temp. storage	+125°C, 1000h		n=22,C=0	
Low temp. storage	-40°C, 1000h		n=22,C=0	
Operation life	$I_{\rm F}$ =50mA, $I_{\rm T}$ =50mA(θ =180°)		n=22,C=0	
Орегацол ме	Ta=25℃, 1000h			

- *1 Test method, conforms to EIAJ ED 4701.
- *2 Solder shall adhere at the area of 95% or more of immersed portion of lead, and pin hole or other holes shall not be concentrated on one portion.
- *3 The lead pin depth dipped into solder shall be 0.2mm away from the root of lead pins.
- *4 Terminal bending direction is shown below.



5. Outgoing inspection

- 5.1 Inspection items
 - (1) Electrical characteristics $V_{F},\,I_{R},\,I_{DRM},\,V_{T},\,I_{FT},\,R_{ISO},\,Viso$
 - (2) Appearance
- 5.2 Sampling method and Inspection level

A single sampling plan, normal inspection level II based on ISO 2859 is applied. The AQL according to the inspection items are shown below.

Defect	Inspection item	AQL(%)	
Major defect	Electrical characteristics Unreadable marking	0.065	
Minor defect	Appearance defect except the above mentioned.	0.25	

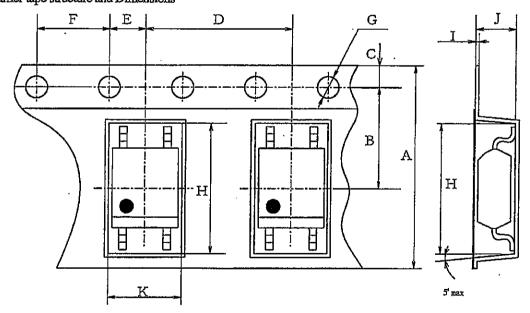
6.2 Package specifications

- 6.2.1 Taping conditions
 - (1) Tape structure and Dimensions (Refer to the attached sheet, Page 9)

The carrier tape has the heat pressed structure of PS material carries tape and three layers cover tape (PET material base).

- (2) Reel structure and Dimensions (Refer to the attached sheet, Page 10)
 - The taping reel shall be of plastic (PS material).
- (3) Direction of product insertion (Refer to the attached sheet, Page 10)
 - Product direction in carrier tape shall direct to the anode mark at the hole side on the tape.
- (4) Joint of tape
 - The cover tape and carrier tape in one reel shall be jointless.
- (5) The way to repair taped failure devices
 - The way to repair taped failure devices cut a bottom of carrier tape with a cutter, and after replacing to good devices, the cut portion shall be sealed with adhesive tape.
- 6.2.2 Adhesiveness of cover tape
 - The exfoliation force between carrier tape and cover tape shall be 0.2N to 0.7N for the angle from 160° to 180°.
- 6.2.3 Rolling method and quantity
 - Wind the tape back on the reel so that the cover tape will be outside the tape.
 Attach more than 20cm of blank tape to the trailer and the leader of the tape and fix the both ends with adhesive tape.
 One reel shall contain 3000pcs.
- 6.2.4 Outer packing appearance (Refer to attached sheet, Page 9)
- 6.2.5 Marking
 - The outer packaging case shall be marked with following information.
 - * Model No. * Number of pieces delivered * Production date
- 6.2.6 Storage condition
 - Taped products shall be stored at the temperature 5 to 30°C and the humidities lower than 70%RH.
- 6.2.7 Safety protection during shipping
 - There shall be no deformation of component or degradation of electrical characteristics due to shipping.

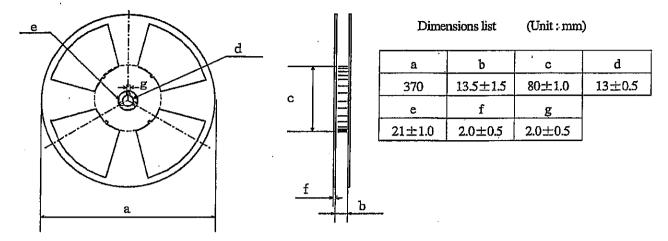
Carrier tape structure and Dimensions



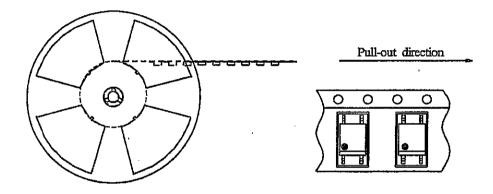
Dimensions list (Unit: mm)

ſ	A	В	С	D	Е	F	G	H	Ì	J	K
	±0.3	±0.05	±0.1	±0.1	±0.05	±0.1	+0.1 -0.0	±0.1	±0.05	±0.1	±0.1
	12.0	5.5	1.75	8.0	2.0	4.0	φ 1.5	7.4	0.3	3.1	4.0

Reel structure and Dimensions



Direction of product insertion



Outer packing appearance

